

# STPS20L40C

## Low drop power Schottky rectifier

### Main product characteristics

I <sub>F(AV)</sub>	2 x 10 A
V <sub>RRM</sub>	40 V
T <sub>j</sub> (max)	150° C
V <sub>F</sub> (max)	0.5 V

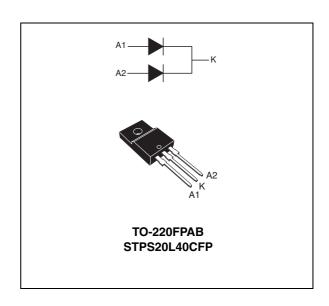
#### Features and benefits

- Low forward voltage drop meaning very small conduction losses
- Low dynamic losses as a result of the schottky barrier
- Insulated package: TO-220FPAB insulating voltage = 200 V DC capacitance = 12 pF
- Avalanche capability specified

#### **Description**

Dual center tap Schottky rectifiers designed for high frequency switched mode power supplies and DC to DC converters.

These devices are intended for use in low voltage, high frequency inverters, free-wheeling and polarity protection applications.



Characteristics STPS20L40C

### 1 Characteristics

Table 1. Absolute Ratings (limiting values)

Symbol	Parameter	Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage		4		V
I <sub>F(RMS)</sub>	RMS forward voltage				Α
I <sub>F(AV)</sub>	Average forward current $T_c = 115^{\circ} C$ Per diode $\delta = 0.5$ Per device		10 20	Α	
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms Si	= 10 ms Sinusoidal 180		Α
I <sub>RRM</sub>	Peak repetitive reverse current	$t_p = 2 \mu s \text{ square } F = 1 \text{ kHz}$		1	Α
I <sub>RSM</sub>	Non repetitive peak reverse current	e current $t_p = 100 \mu s \text{ square}$			Α
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p = 1 \mu s T_j = 25^{\circ}C$			4000	W
T <sub>stg</sub>	Storage temperature range	-65 to + 150	°C		
Tj	Maximum operating junction temperature (1)			150	°C
dV/dt	Critical rate of rise of reverse voltage 1000			10000	V/µs

<sup>1.</sup>  $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

Table 2. Thermal resistances

Symbol	Parameter	Value	Unit	
R <sub>th(j-c)</sub>	Junction to case	Per diode Total Coupling	4.5 3.5 2.5	°C/W

When the diodes 1 and 2 are used simultaneously :  $\Delta \text{Tj(diode 1)} = P(\text{diode1}) \text{ x } R_{\text{th(j-c)}}(\text{Per diode}) + P(\text{diode 2}) \text{ x } R_{\text{th(c)}}.$ 

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
ı (1)	Reverse leakage current	T <sub>j</sub> = 25° C	$V_R = V_{RRM}$			0.7	mA
'R`		T <sub>j</sub> = 100° C			15	35	mA
	V <sub>F</sub> <sup>(1)</sup> Forward voltage drop	T <sub>j</sub> = 25° C	I <sub>F</sub> = 10 A			0.55	
V (1)		T <sub>j</sub> = 125° C	I <sub>F</sub> = 10 A		0.44	0.5	v
VF`		T <sub>j</sub> = 25° C	I <sub>F</sub> = 20 A			0.73	v
		T <sub>j</sub> = 125° C	I <sub>F</sub> = 20 A		0.62	0.72	

<sup>1.</sup> Pulse test: tp = 380  $\mu$ s,  $\delta$  < 2%

To evaluate the conduction losses use the following equation:

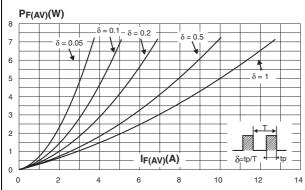
$$P = 0.28 \times I_{F(AV)} + 0.022 I_{F}^{2}(RMS)$$

5

STPS20L40C Characteristics

Figure 1. Average forward power dissipation versus average forward current (per diode)

Figure 2. Average forward current versus ambient temperature  $(\delta = 0.5, per diode)$ 



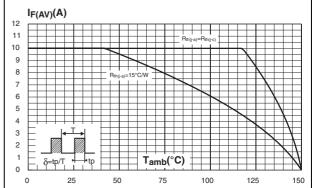
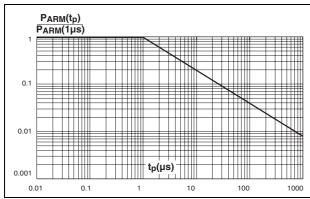


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature



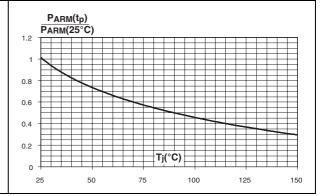
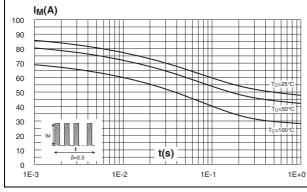
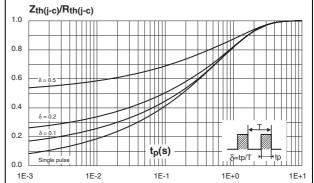


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values, per diode)

Figure 6. Relative variation of thermal impedance junction to case versus pulse duration





5/

Characteristics STPS20L40C

Figure 7. Reverse leakage current versus reverse voltage applied (typical values, per diode)

Figure 8. Junction capacitance versus reverse voltage applied (typical values, per diode)

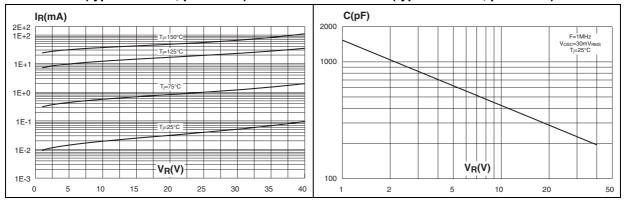
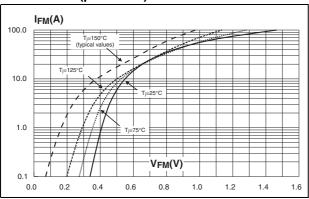


Figure 9. Forward voltage drop versus forward current (maximum values) (per diode)



577

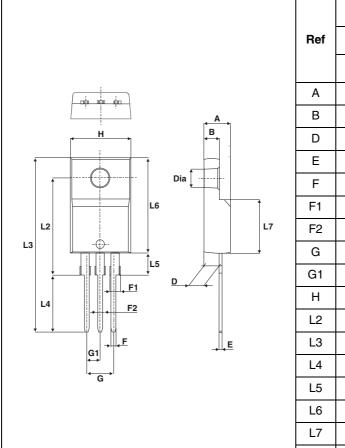
STPS20L40C Package Information

## 2 Package Information

Epoxy meets UL94, V0

Cooling method: by conduction (C)
Recommended torque value: 0.55 Nm
Maximum torque value: 0.70 Nm

Table 4. TO-220FPAB dimensions



	Dimensions			
Ref	Millim	neters	Inc	hes
	Min.	Max.	Min.	Max.
Α	4.4	4.6	0.173	0.181
В	2.5	2.7	0.098	0.106
D	2.5	2.75	0.098	0.108
Е	0.45	0.70	0.018	0.027
F	0.75	1	0.030	0.039
F1	1.15	1.70	0.045	0.067
F2	1.15	1.70	0.045	0.067
G	4.95	5.20	0.195	0.205
G1	2.4	2.7	0.094	0.106
Н	10	10.4	0.393	0.409
L2	16	Тур.	0.63	Тур.
L3	28.6	30.6	1.126	1.205
L4	9.8	10.6	0.386	0.417
L5	2.9	3.6	0.114	0.142
L6	15.9	16.4	0.626	0.646
L7	9.00	9.30	0.354	0.366
Dia.	3.00	3.20	0.118	0.126

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

57

Ordering information STPS20L40C

# 3 Ordering information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS20L40CFP	STPS20L40CFP	TO-220FPAB	2 g	50	Tube

# 4 Revision history

Date	Revision	Description of Changes
Jul_2003	4B	Last release.
26-Mar-2007	5	Removed ISOWATT, TO-220AB and TO-247 packages.

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

